



Response under 37 CFR 1.116 — Expedited Procedure
Examining Group

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Attorney Docket No. 3481P009D

Patent

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re of Application of:

Joseph Wytman

Application No.: 09/825,648

Filing Date: April 4, 2001

For: METHOD OF PROCESSING WAFERS USING A
COMPLIANT WAFER CHUCK (AS AMENDED)

Examiner: Mutschler, Brian L.

Art Group: 1753

Mail Stop: AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE TO FINAL OFFICE ACTION

Sir:

In response to the Office Action of August 20, 2003, please enter the following amendments. The amendments are believed to place the application in condition for allowance as further explained below.

Amendments to the Claims are reflected in the listing of claims, which begins on page 2 of this paper.

Remarks/Arguments begin on page 4 of this paper.

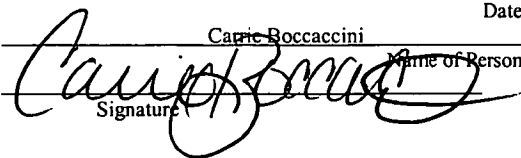
I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on

November 19, 2003

Date of Deposit

Carmine Boccaccini

Name of Person Mailing Correspondence



Signature

11-19-2003

Date